



MEDIA TEK

COM Simulation and Analysis for 200Gbps/Lane CR

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IEEE P802.3df Task Force

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Outline

- **Overview**
- **Link Budget Analysis for 200G/L PAM4 CR**
- **Channel Feasibility: Key Challenges**
- **SerDes Feasibility: COM Sensitivity to Key Parameters**
- **Modulation Type for 200G/L CR: PAM4 vs PAM6**
- **Conclusion**

Motivation and Methodology

- **Explore feasibility of 200G/L PAM4 CR**
 - Channel & SerDes requirements?
- **Analyze channel requirements – based on COM v3.70 simulation**
 - All available 200G CR channels from IEEE, OIF, & OSFP (total 73x)
 - Based on baseline SerDes
- **Assess SerDes feasibility – starting from COM sensitivity check with sweeping key SerDes parameters**
 - Provide the directions to make good trade-off between performance & power/cost of SerDes
 - Allow the interoperability between channel & SerDes improvements
- **Investigate modulation format for 200G/L CR – comparing PAM4 & PAM6 under the assumption of identical transceiver capability**

Objectives

- **Do**

- Leverage published channel materials to represent potential 200Gbase channel characteristics and evaluate their corresponding performance
- Analyze 200G/L CR feasibility from the system's point of view
- Point out key challenges of channel: roll-off characterizing impairments, reflection, & crosstalk
- Provide direction of next generation SerDes: COM sensitivity of key parameters
- Provide the baseline performance for candidate modulation formats

- **Don't**

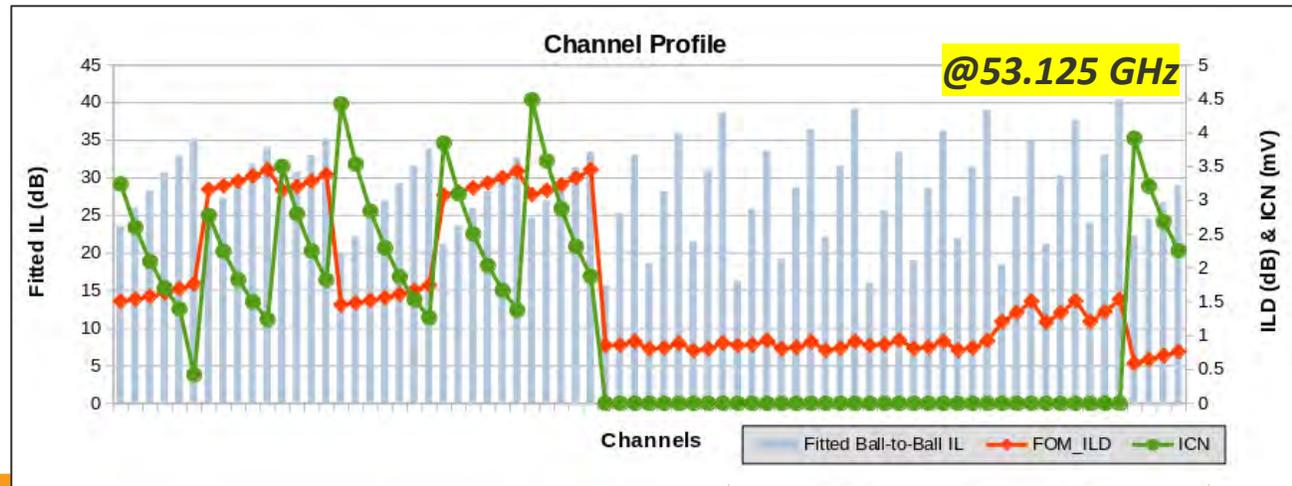
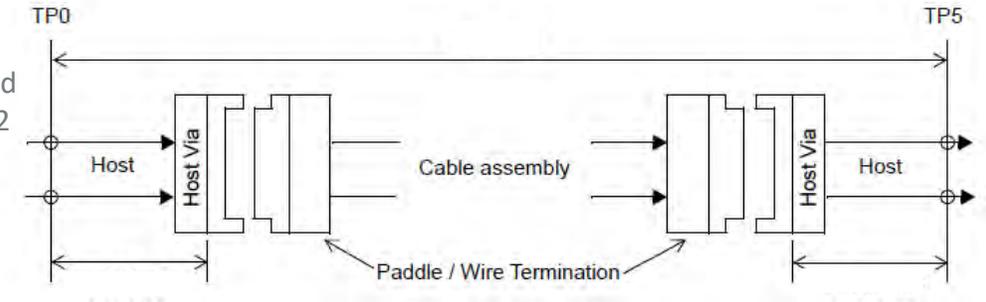
- Offer the SerDes or channel solutions
- Draw conclusions on modulation type for 200G/L CR

CR Channel Profile

- Channel variations mainly come from
 - Host PCB length
 - Cable length, impedance, & AWG
 - Verticals (connector & BGA breakout region)
 - Crosstalk
- Total of 73 channels

Source	Contributor	LR Channels
1. OSFP 200GEL	Amphenol	<ul style="list-style-type: none"> • 0.5/1m 27AWG CA • 1"-7" PCB at each side (92 Ohm, 1.3dB/in @56GHz) • BGA breakout: parallel/orthogonal (no skew)/orthogonal • Crosstalk mainly comes from connector via
	Amphenol	
	Keysight	
2. mellitz 3df 01 220502	Samtec	<ul style="list-style-type: none"> • 0.5/1m/1.5 27AWG CA (100Ohm target) • 2"/5"/7.45" PCB at each side (1.6dB/in @53.125GHz) • Termination: T-line (ideal)/SMA 1.0mm/SMA 1.85mm/via 28mm • No crosstalk
3. oif2022.194.00	Samtec	<ul style="list-style-type: none"> • 1/1.5m 28AWG CA (92.5 Ohm) • Cable backplane with connector direct to package: 100/250 mm 34 AWG (92.5 Ohm) • Direct to package connector (Cp and Zp2 set to zero) • Crosstalk mainly comes from connector via

BGA breakout included in channel group 1 & 2



The objective is to explore diverse channels to assess LR technology feasibility

- Channel IL: 16~42 dB
- FOM_ILD: 0.93~4.23 dB

COM Simulation Consideration: 200G Baseline

Table 93A-1 parameters				I/O control			Table 93A-3 parameters		
Parameter	Setting	Units	Information	Parameter	Setting	Units	Parameter	Setting	Units
f_b	106.25	GBd		DIAGNOSTICS	1	logical	package_tl_gamma0_a1_a2	[0 0.000644085 0.00018018]	
f_min	0.05	GHz		DISPLAY_WINDOW	0	logical	package_tl_tau	5.700E-03	ns/mm
Delta_f	0.01	GHz		CSY_REPORT	0	logical	package_Z_c	[87.5 87.5 ; 92.5 92.5]	Ohm
C_d	[0.7e-4 0.7e-4]	nF	[TX RX]	RESULT_DIR	.\results\100GEL	C2M_host_(da	ICN & FOM ILD parameters		
L_s	[0.12 0.12]	nH	[TX RX]	SAVE_FIGURES	0	logical	f_v	0.594	*Fb
C_b	[0.3e-4 0.3e-4]	nF	[TX RX]	Port Order	[1 3 2 4]		f_f	0.594	kHz f_r specified in first column
z_p select	[1 2]		[test cases to run]	RUNTAG	CR_eyal_		f_n	0.594	GHz
z_p (TX)	[12 31; 1.8 1.8]	mm	[test cases]	COM_CONTRIBUTION	0	logical	f_2	80	GHz
z_p (NEXT)	[12 29; 1.8 1.8]	mm	[test cases]	Local Search	2		A_ft	0.600	V
z_p (FEXT)	[12 31; 1.8 1.8]	mm	[test cases]	Operational			A_nt	0.600	V
z_p (RX)	[12 29; 1.8 1.8]	mm	[test cases]	VEC Pass threshold	12	db	Histogram_Window_Weight gaussian Selections (rectangle, gaussian)		
C_p	[0.87e-4 0.87e-4]	nF	[TX RX]	EH_min	10	mV	COM Pass threshold 3		
R_0	50	Ohm		ERL Pass threshold	9.5	dB			
R_d	[50 50]	Ohm	[TX RX]	Min_VEQ_Test	0	mV			
A_v	0.413	V		DER_0	0.0001				
A_fe	0.413	V		T_r	0.0037496470588	ns			
A_ne	0.608	V		FORCE_TR	1	logical			
L	4								
M	32	amp/U							
samples_for_C2M	32	amp/U							
T_0	0	mU							
AC_CM_RMS	0	V	[test cases]						
filter and Eq									
f_r	0.75	*fb							
c(0)	0.5		min						
c(-1)	[-0.4;0.02;0.04]		[min;step;max]						
c(-2)	[-0.1;0.02;0.2]		[min;step;max]						
c(-3)	[-0.1;0.02;0.1]		[min;step;max]						
c(1)	[-0.2;0.02;0.1]		[min;step;max]						
N_b	24	UI							
b_max(1)	0.85		As/dffe1						
b_max(2..N_b)	[0.5 0.3 0.3 0.2*ones(1,20)]		As/dfe2..N_b						
b_min(1)	0.3		As/dffe1						
b_min(2..N_b)	[0.2 0.05 0.05 -0.03*ones(1,20)]		As/dfe2..N_b						
g_DC	[-20;1;-2]	dB	[min;step;max]						
f_z	42.5	GHz							
f_p1	42.5	GHz							
f_p2	106.25	GHz							
g_DC_HP	[-6;1;0]		[min;step;max]						
f_HP_PZ	1.328125	GHz							
G_Qual	[-2 -20 ; -2 -20; -2 -20; -2 -20]	dB	ranges						
G2_Qual	[0 -1 -2 -6]	dB	ranges						

- Die model : keep the similar IL as 100G (parameters need further investigation)
- PKG model: 25% trace loss improvement from 100G, follows the values proposed in oif2021.596.01 (parameters need further investigation)
- RXEQ length/rise time/jitter/RX noise PSD scaled with 2x baud rate
- DER/TX swing/TX SNR/Nonlinearity/TXEQ length kept the same as 100G
- COM version: 3.70
- Test case (TC) 1 (short package): [z_p (TX) z_p (RX)] = [12 12] mm
- TC 2 (long package) : [z_p (TX) z_p (RX)] = [31 29] mm

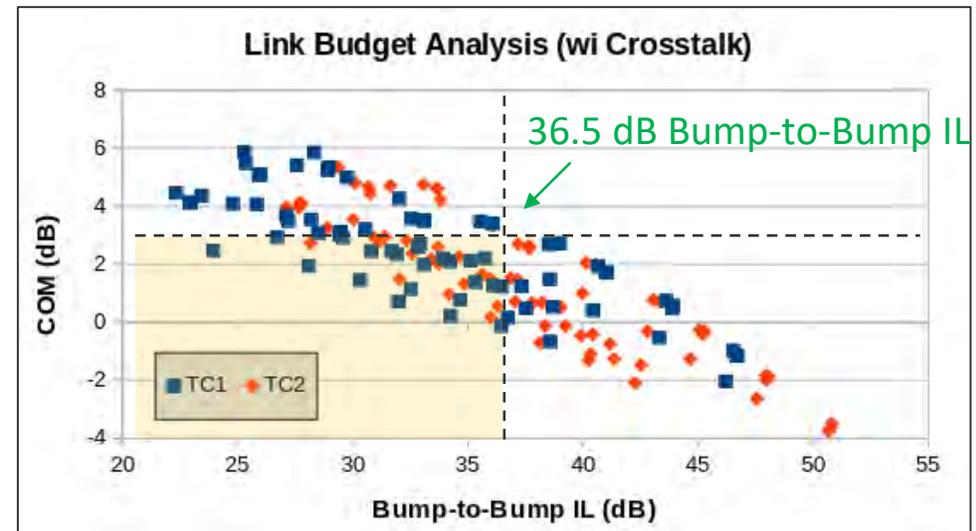
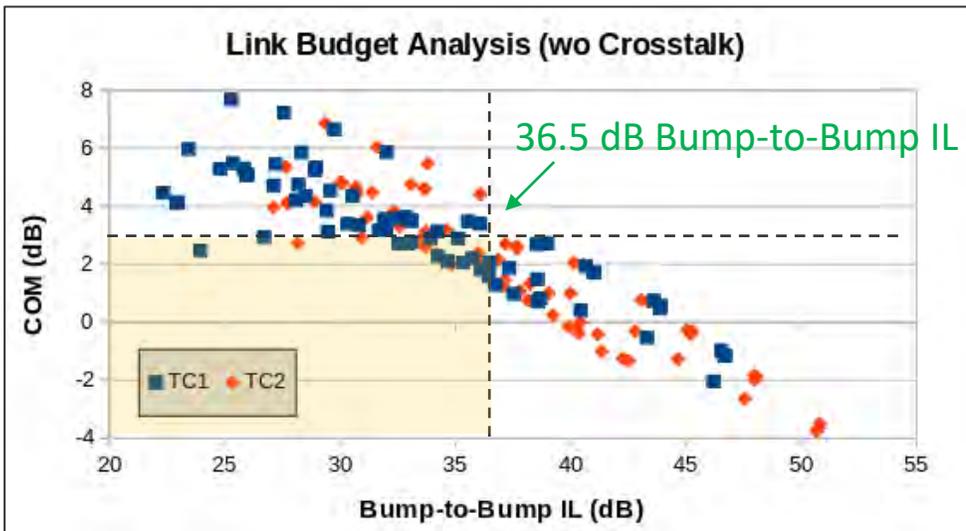
Link Budget Analysis for 200G/L PAM4 CR

- **Whole link budget analysis**

- To allow the interoperability among channel components & point out the design challenges
 - Currently the group don't have consensus in package model → bump-to-bump IL target is evaluated instead of ball-to-ball IL target
- Analyze performance from the system's point of view

- **Whether 200G/L PAM4 CR works?**

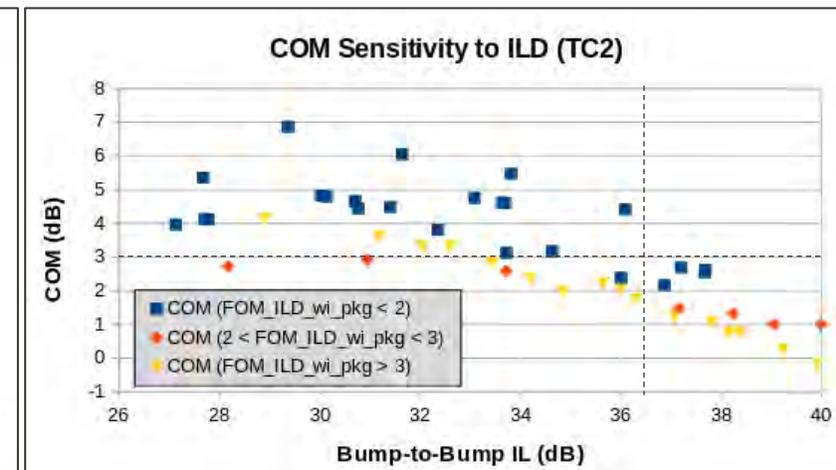
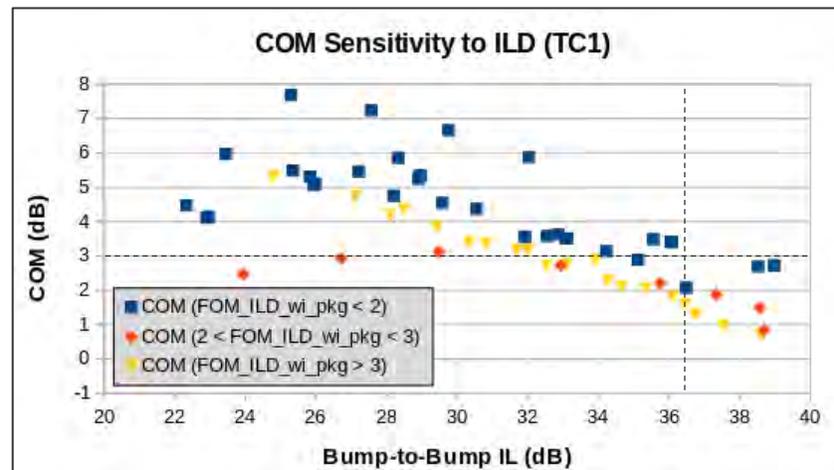
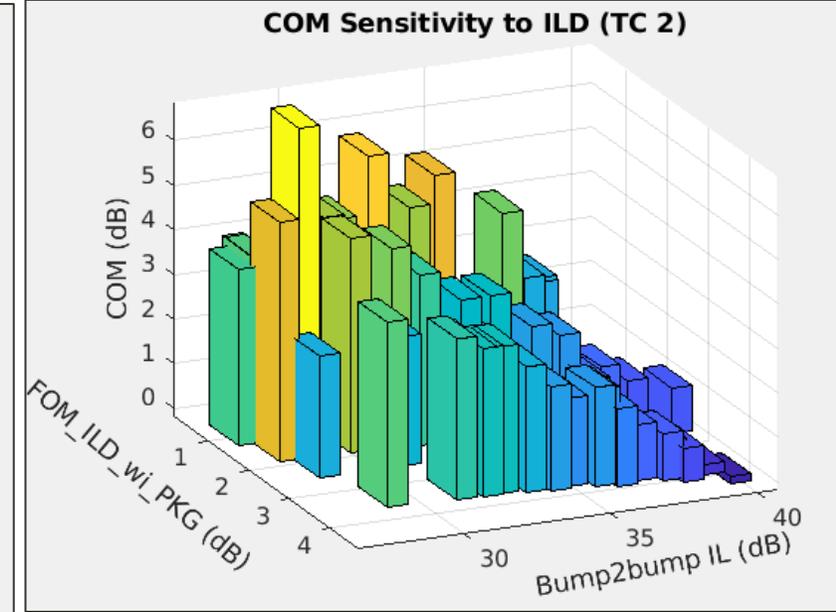
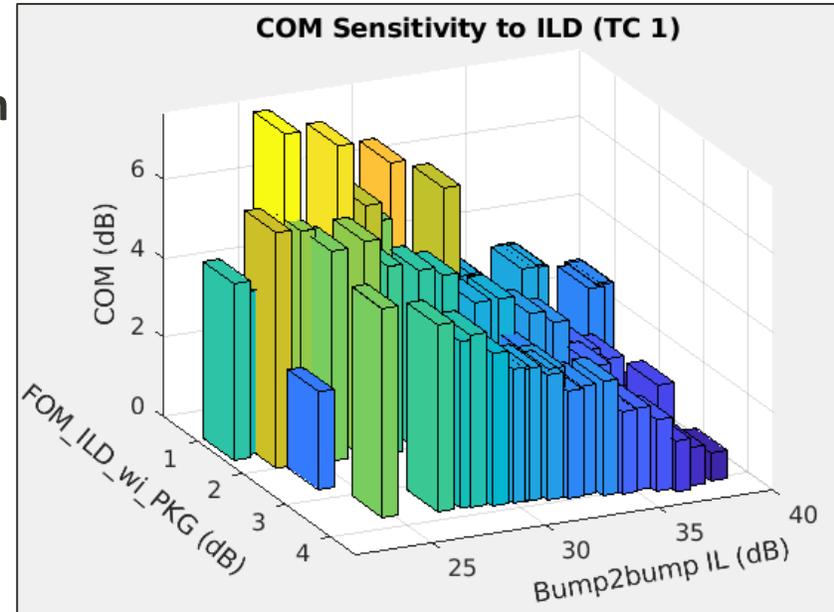
- If keep the same IL target from 100G to 200G: bump-to-bump IL ~ 36.5 dB (28.5dB ball-to-ball + 8 dB PKG in 802.3ck)
- If make SerDes capability aligned from 100G to 200G



Channel Feasibility: ILD

- Resonances characterizing impairments in next generation have been discussed in [noujem 3df 01 220224](#)
- Vertical transition
 - Connector footprint
 - BGA breakout region
 → Can cause multiple reflections
 → Need more banks of floating taps
- Impedance mismatch
 - Connector-BGA breakout
 - Channel-package
 → Reflection issue have been investigated in 802.3ck
 → Length of DFE/floating tab used to compensate reflections is twice of that for 100G/L CR

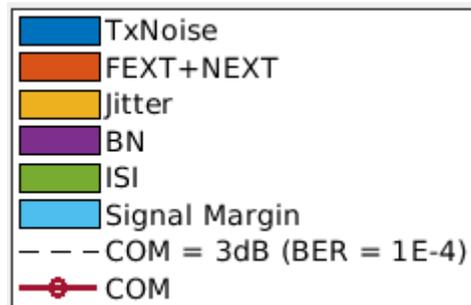
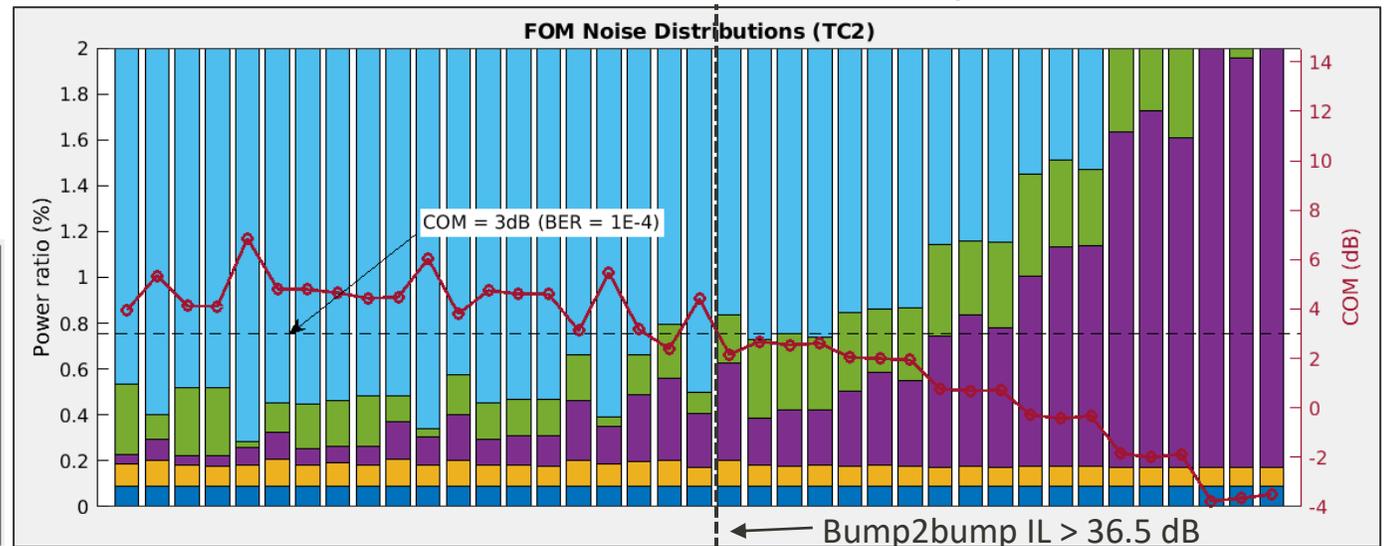
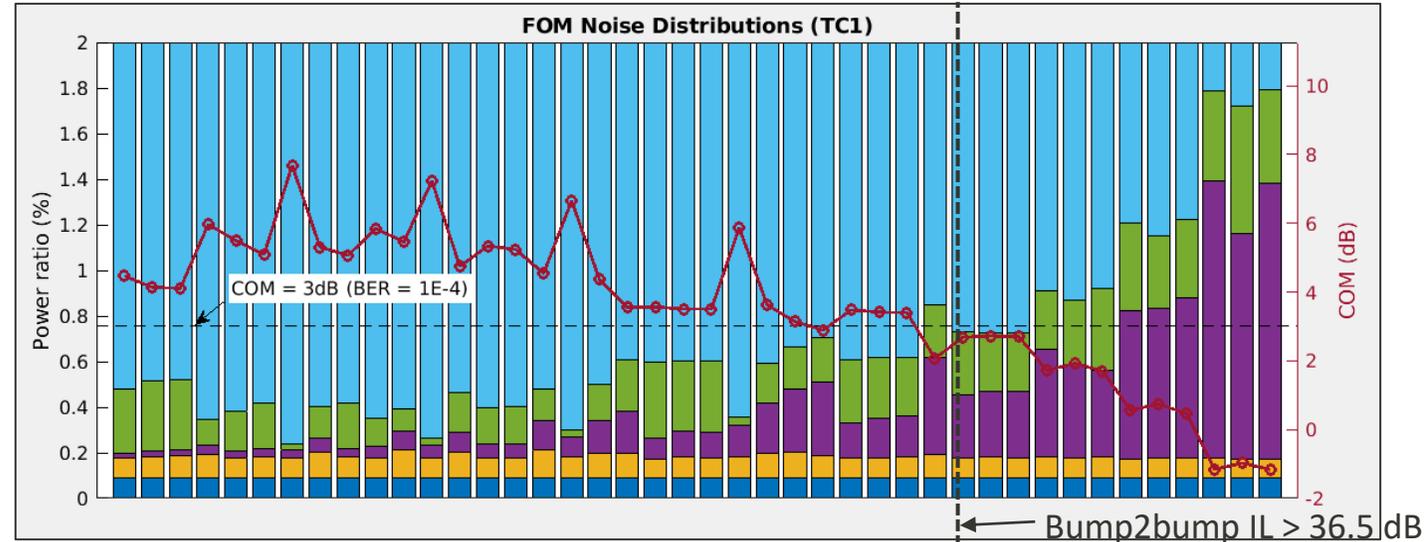
**wo crosstalk*



Noise Distribution (wo Crosstalk)

*Channels with FOM_ILD_wi_PKG <= 2

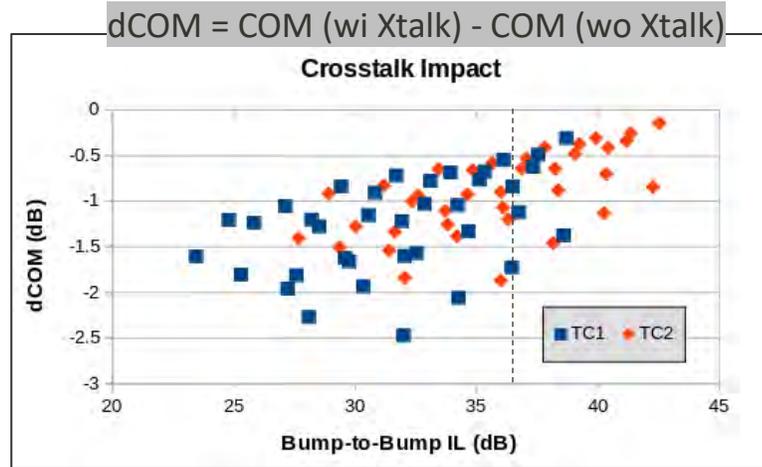
- Basically, performance is limited by noise enhancement with increasing IL
- Reflection-induced residual ISI can further degrade COM



Bump-to-bump IL →

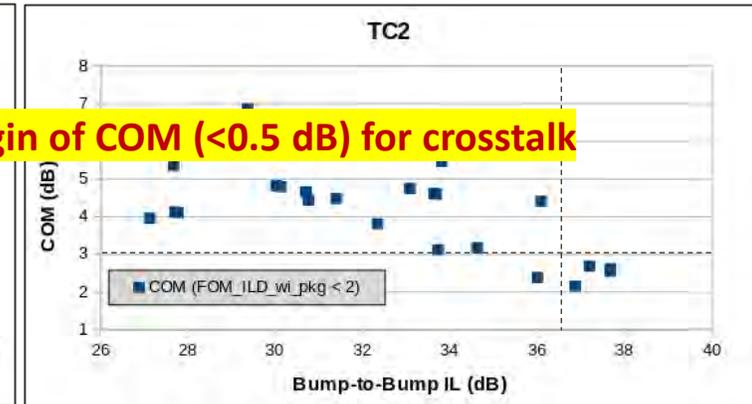
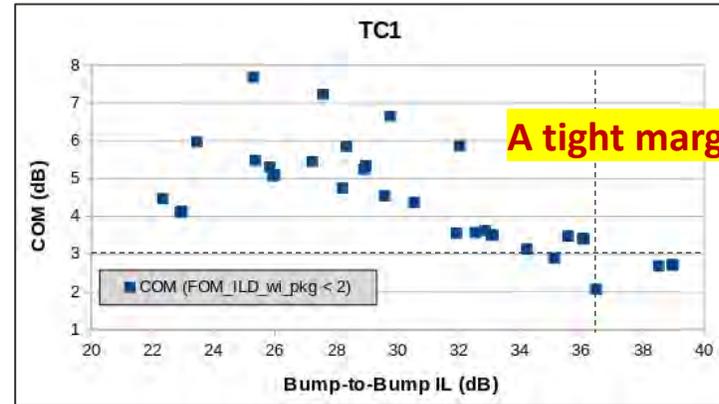
Channel Feasibility: Crosstalk

- **Crosstalk Impact**
 - Crosstalk can degrade COM up to ~2dB at IL of interest

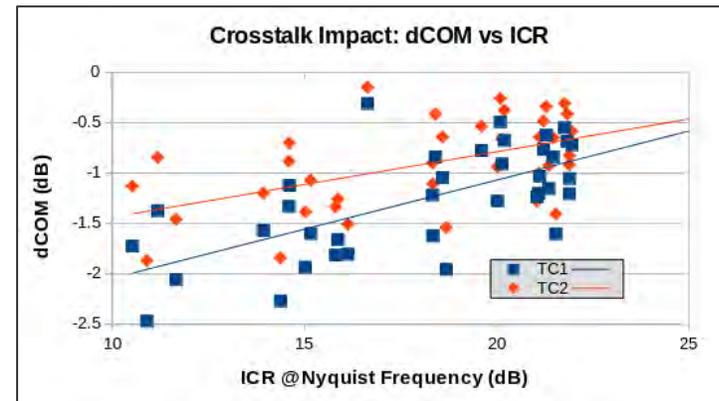


- Insertion-loss-to-crosstalk ratio (ICR) of test channels: 10.5 dB ~ 22 dB

- **Link budget analysis (wo crosstalk)**



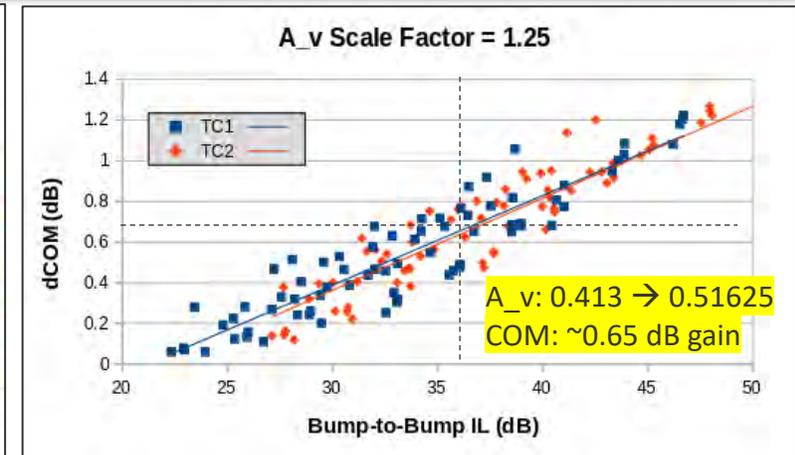
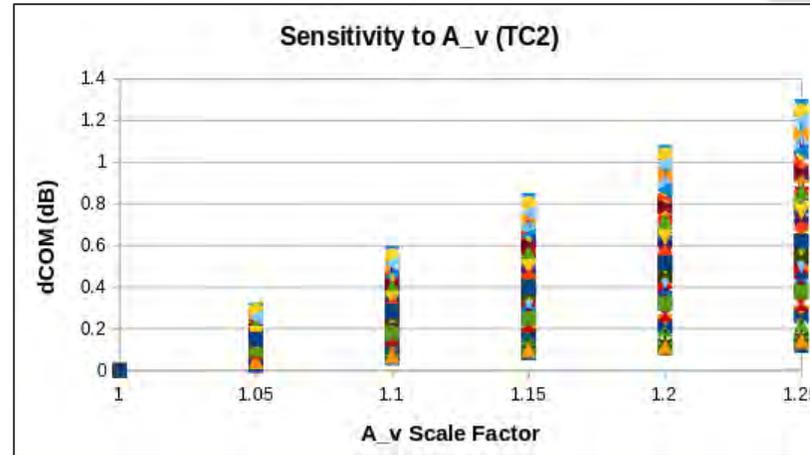
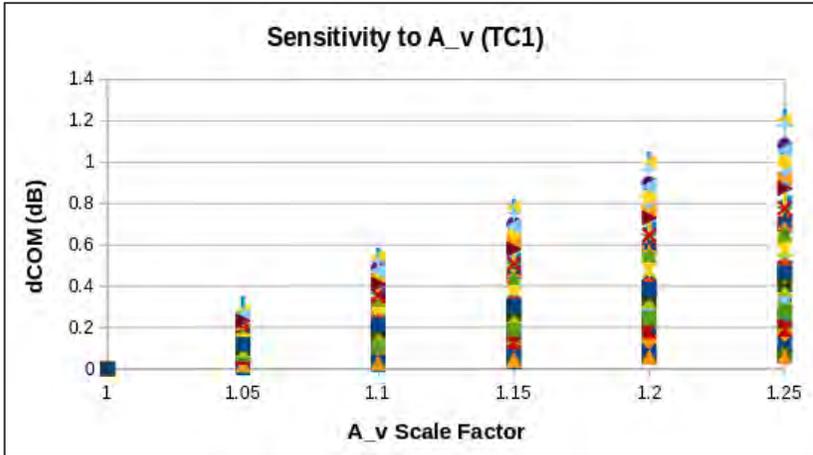
- **Crosstalk limit: ICR \geq 25 dB?**



Sensitivity to Transceiver Capability: A_v & SNR_TX

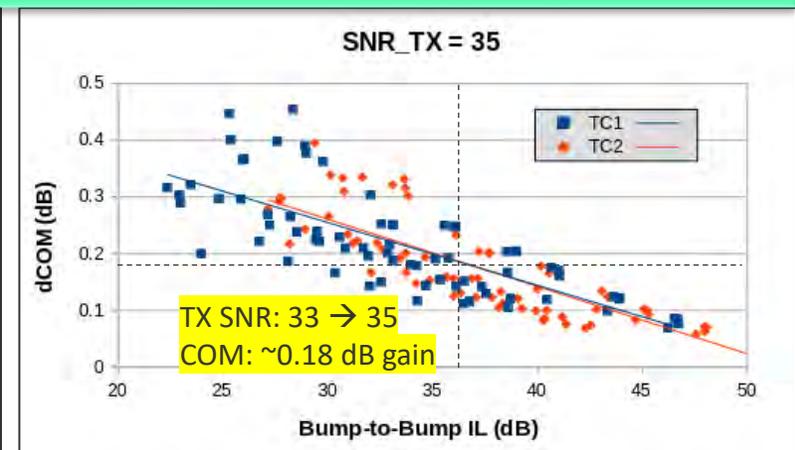
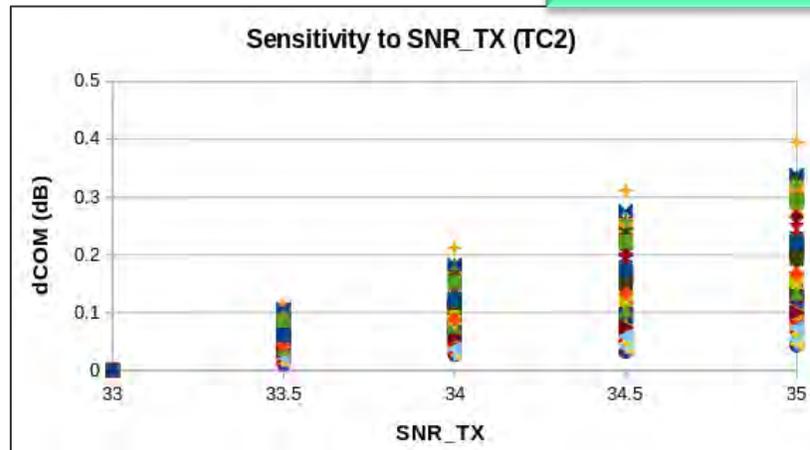
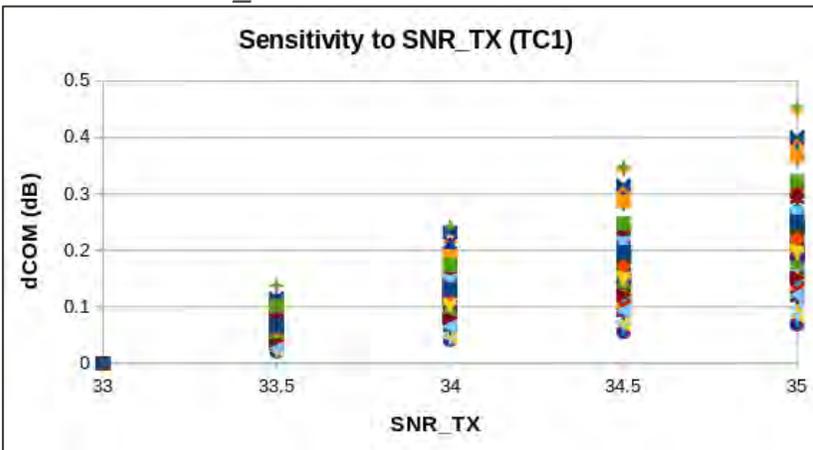
* Baseline: A_v scale factor = 1 (A_v = 0.413 V)

- Increased A_v can help to enlarge signal margin
- Concern: Linearity & power consumption



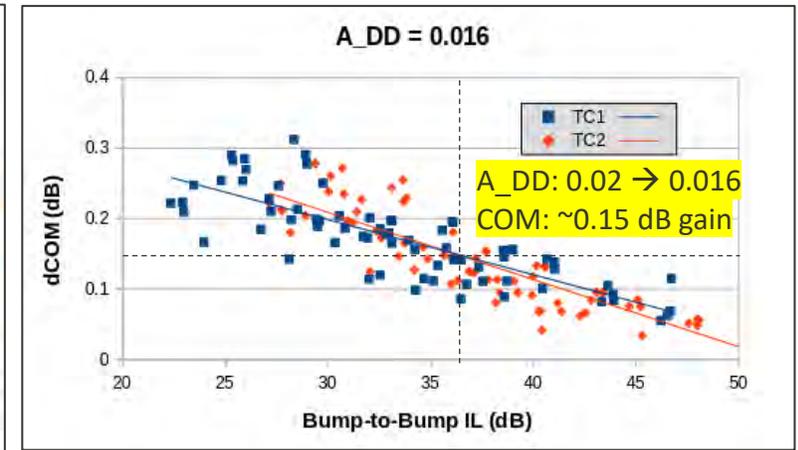
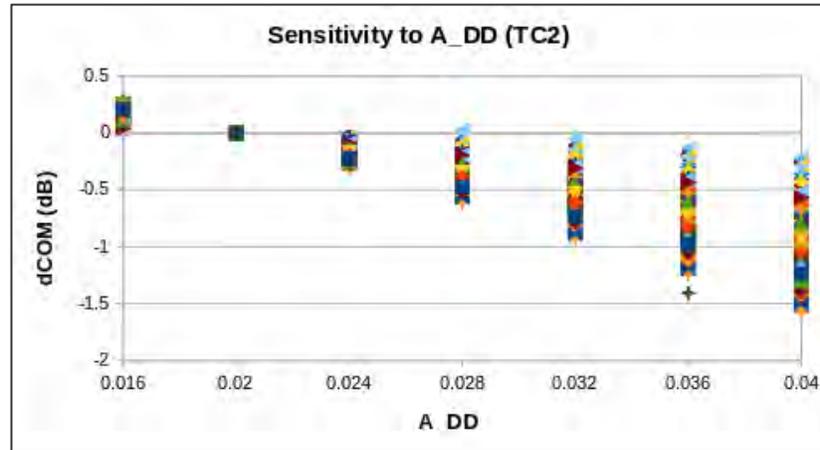
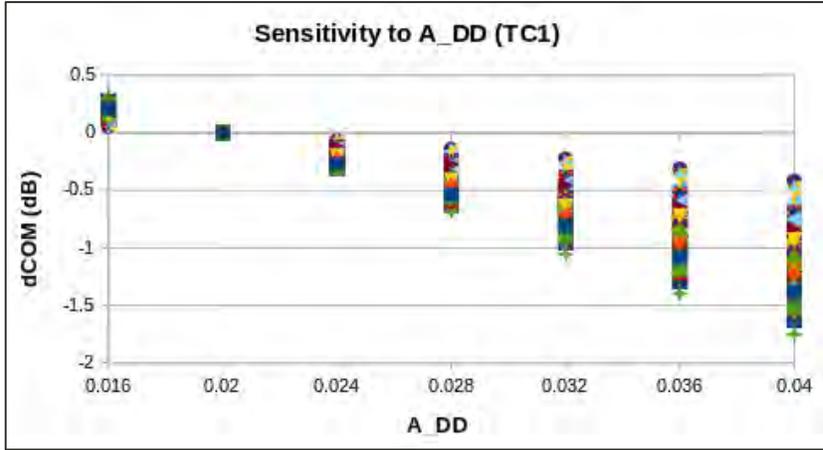
* Baseline: SNR_TX = 33 dB

- TX noise is less significant since ISI dominates the noise budget

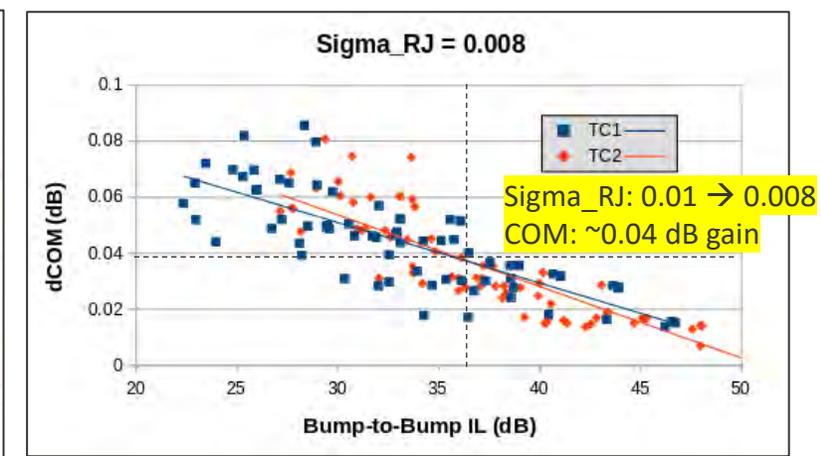
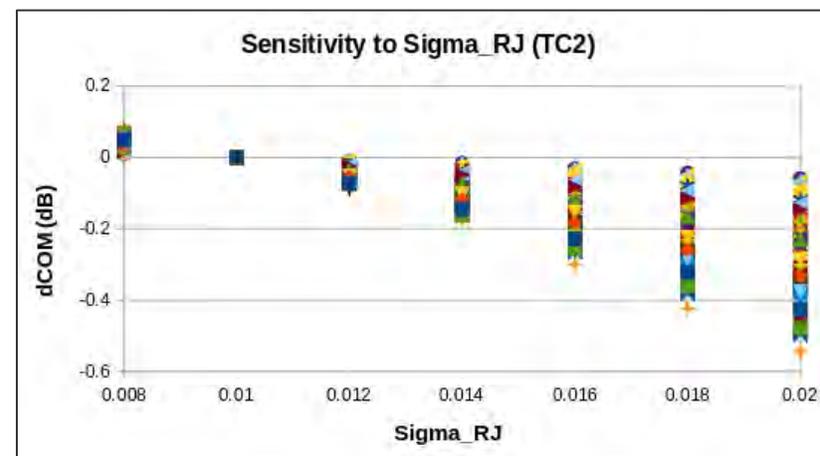
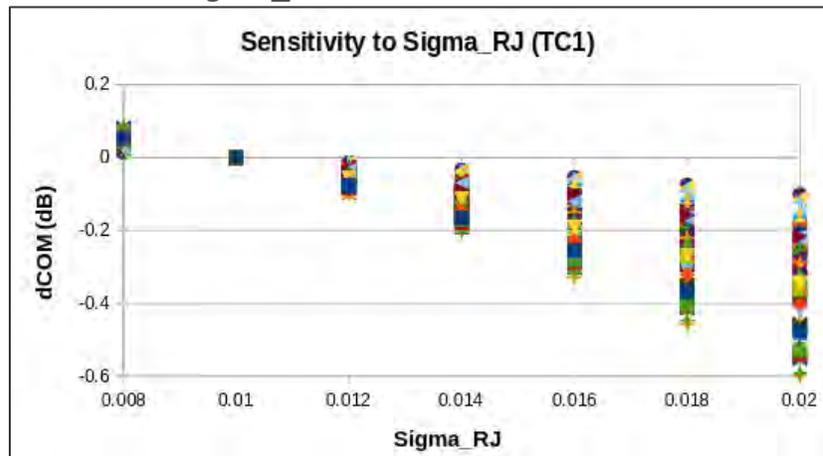


Sensitivity to Transceiver Capability: Jitter

* Baseline: $A_DD = 0.02$

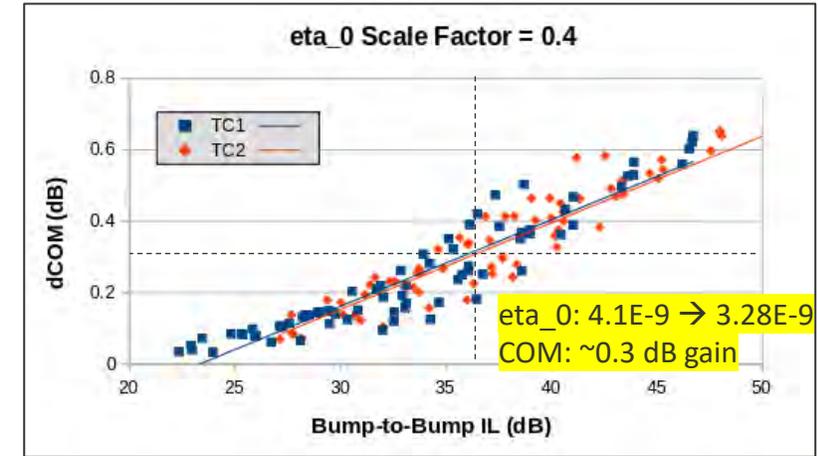
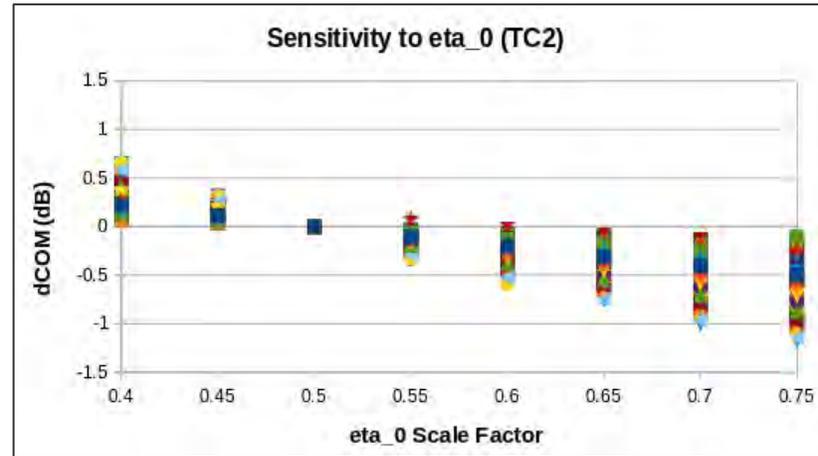
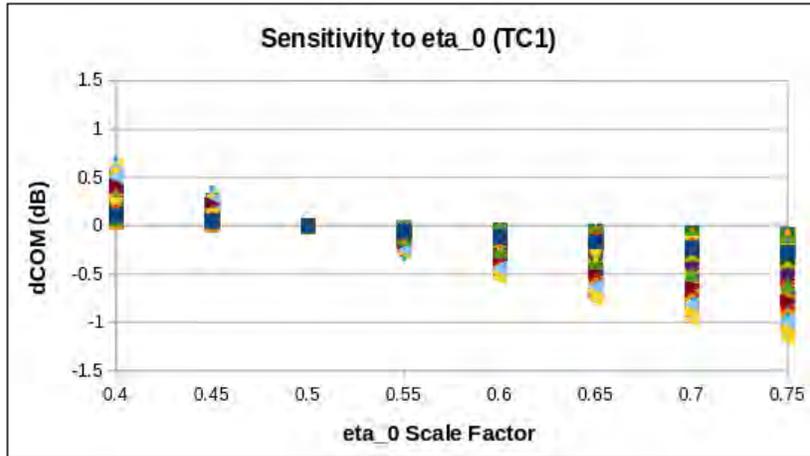


* Baseline: $\text{Sigma_RJ} = 0.01$



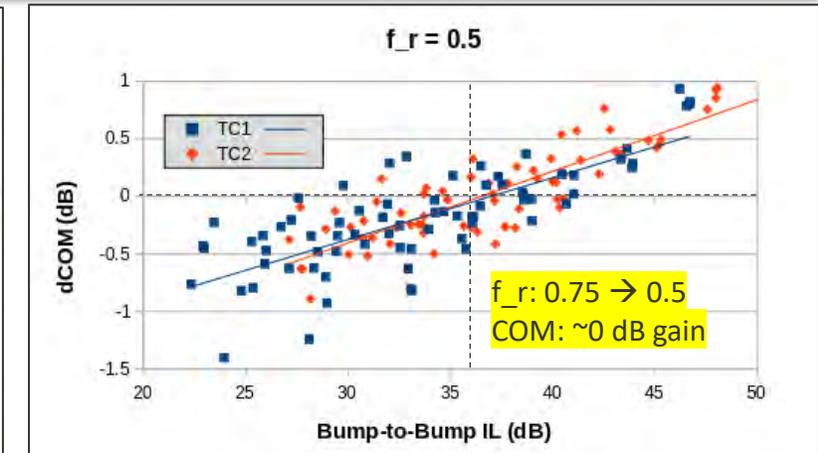
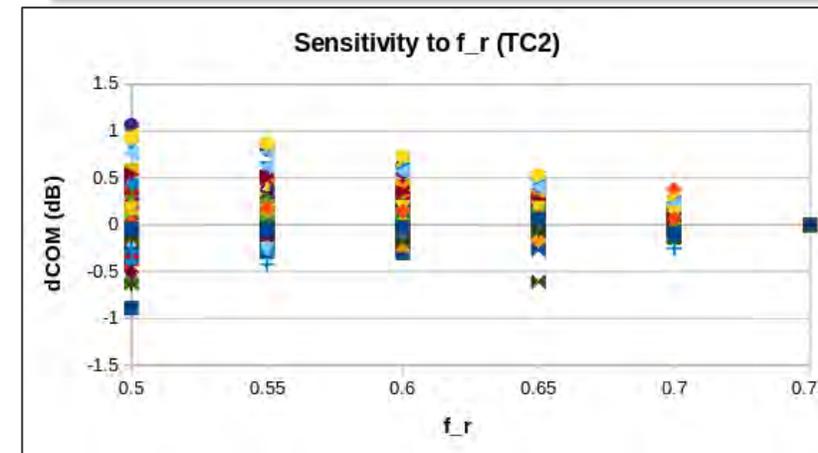
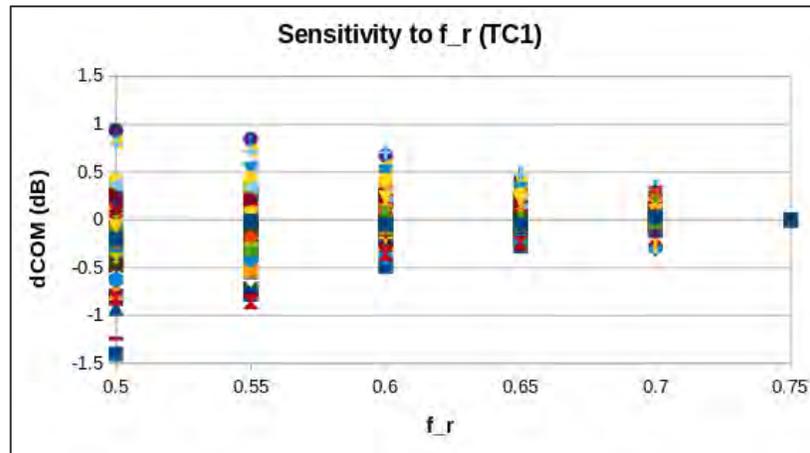
Sensitivity to Transceiver Capability: η_0 & f_r

* Baseline: η_0 scale factor = 0.5 ($\eta_0 = 4.1E-9$)



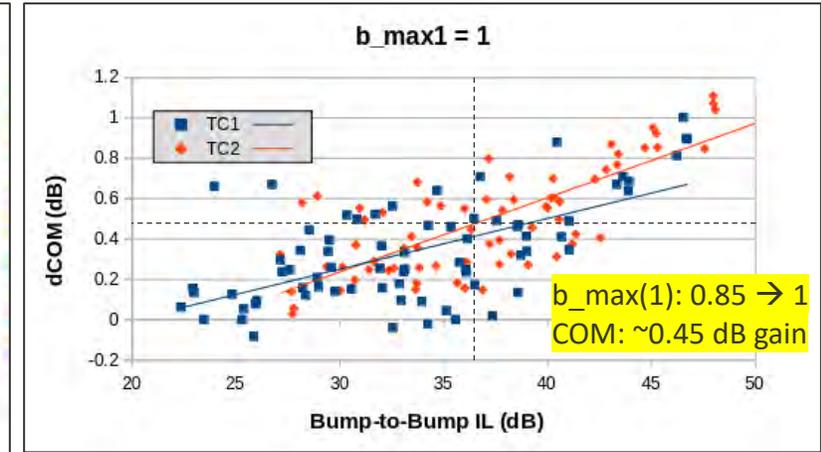
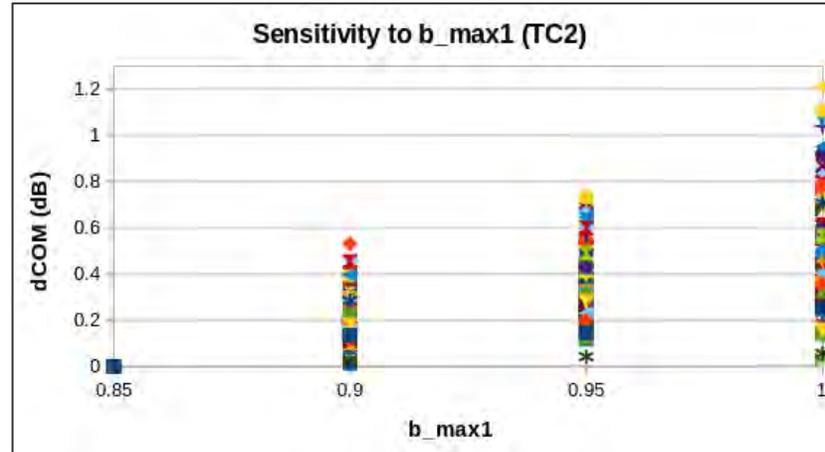
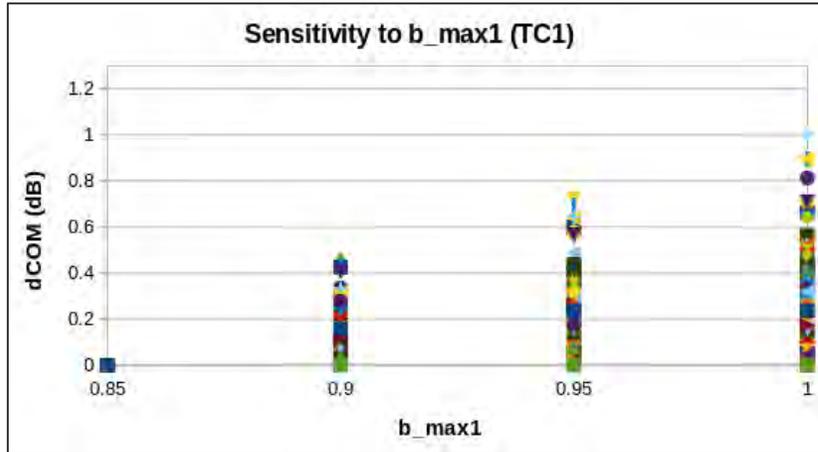
- A proper design of RX filter can achieve a better tradeoff between peaking gain & noise reduction
- Higher loss channels enjoy higher performance gain as reducing f_r

* Baseline: $f_r = 0.75$



Sensitivity to Transceiver Capability: b_{max} (1)

*Baseline: $b_{max}(1) = 0.85$



- **More flexible DFE coefficient range**
 - Beneficial for longer channels due to less noise enhancement induced by CTLE
 - Can help near-main cursor reflections (induced by roll-off)
- **Concern: error propagation**

Summary: Sensitivity to Transceiver Capability

- **Average COM gain obtained by SerDes enhancement**

- Based on TC2 & target bump-to-bump IL = 36.5 dB

	Changes from Baseline	Improvement	COM Gain
A_v	0.413 → 0.51625	25% increased	0.65 dB
SNR_TX	33 → 35	25% increased	0.18 dB
A_DD	0.02 → 0.016	20 % decreased	0.15 dB
Sigma_RJ	0.01 → 0.008	20 % decreased	0.04 dB
eta_0	4.1E-9 → 3.28E-9	20 % decreased	0.30 dB
f_r	0.75 → 0.5		0.00 dB
b_max (1)	0.85 → 1	17% increased	0.45 dB

- **Potential ways to improve the reach of 200G/L CR**

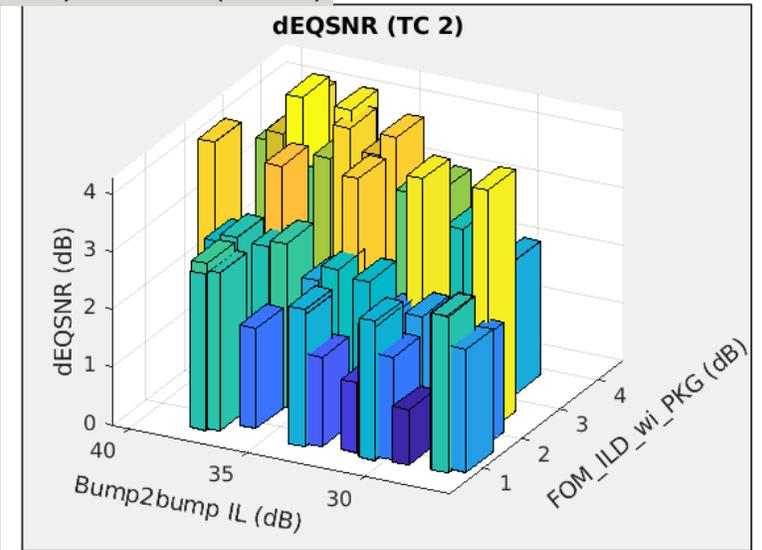
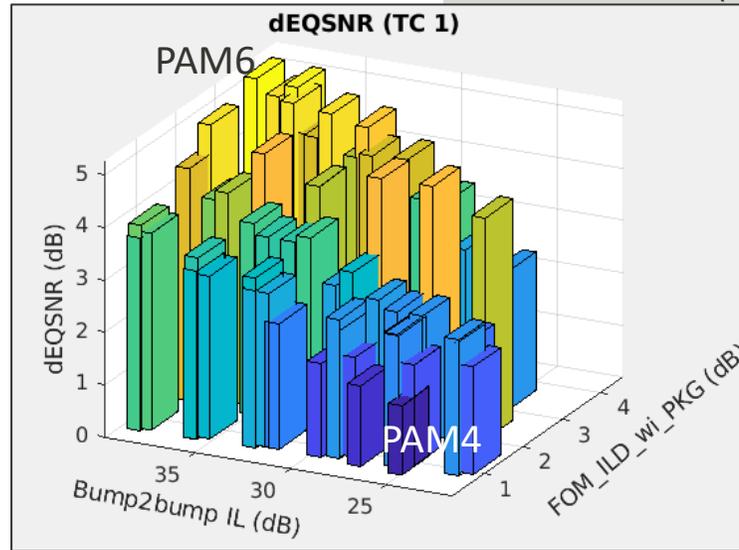
- Increase A_v → Further investigation in linearity & power consumption required
- Increase b_max (1) → Advanced RX technology can help the problem of error propagation?
- Enhance eta_0 → It's very challenging to further improve RX noise

PAM4 vs PAM6 (wo Crosstalk)

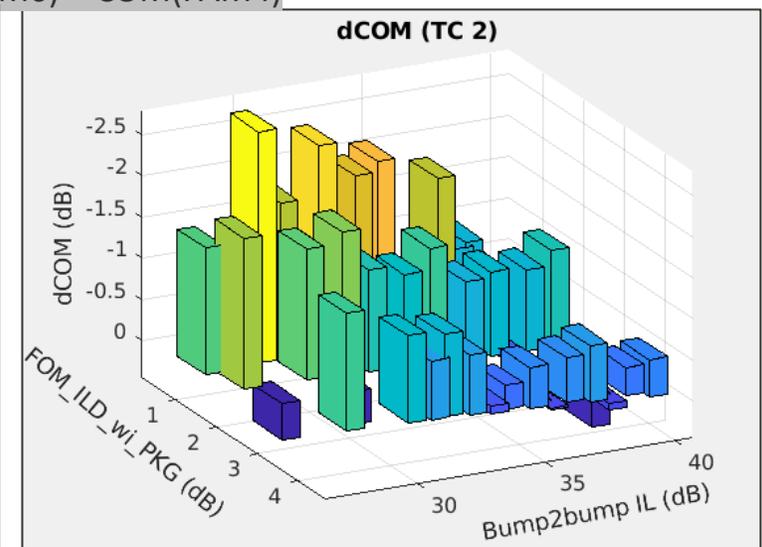
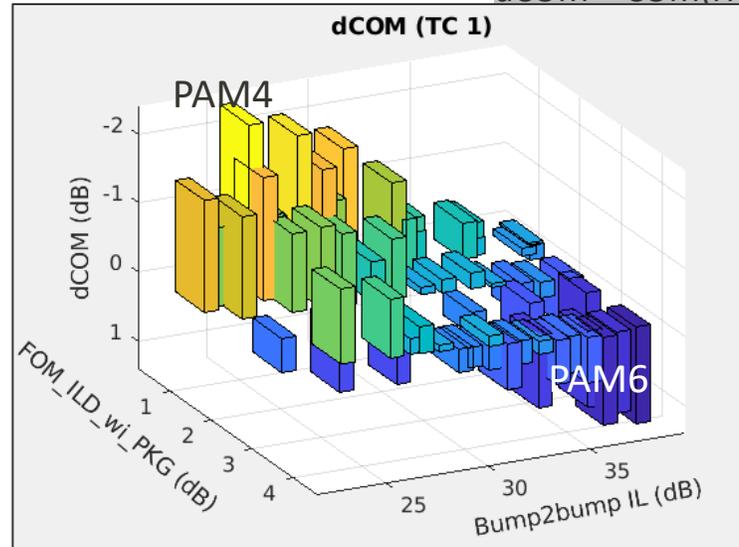
- Assumptions: Identical transceiver capability for both PAM4 & PAM6
 - Identical impairments (absolute values of rise time, jitter, & RX noise)
 - Identical equalizer length

SNR penalty (PAM4 → PAM6)	1E-4	1E-5	1E-6
PAM4	18.23	19.46	20.42
PAM6	21.81	23.06	24.04
SNR Penalty (dB)	3.58	3.6	3.62

$$dEQSNR = EQSNR(PAM6) - EQSNR(PAM4)$$

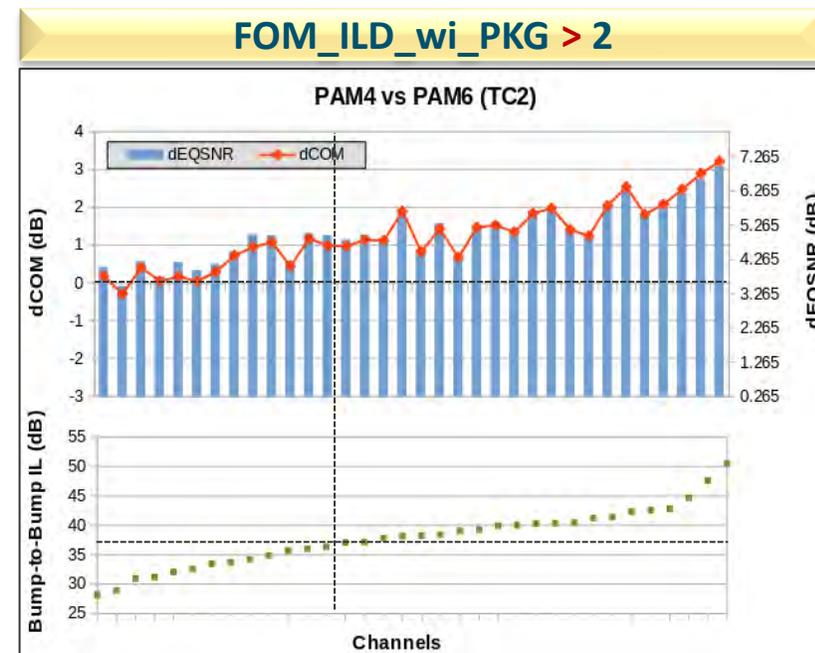
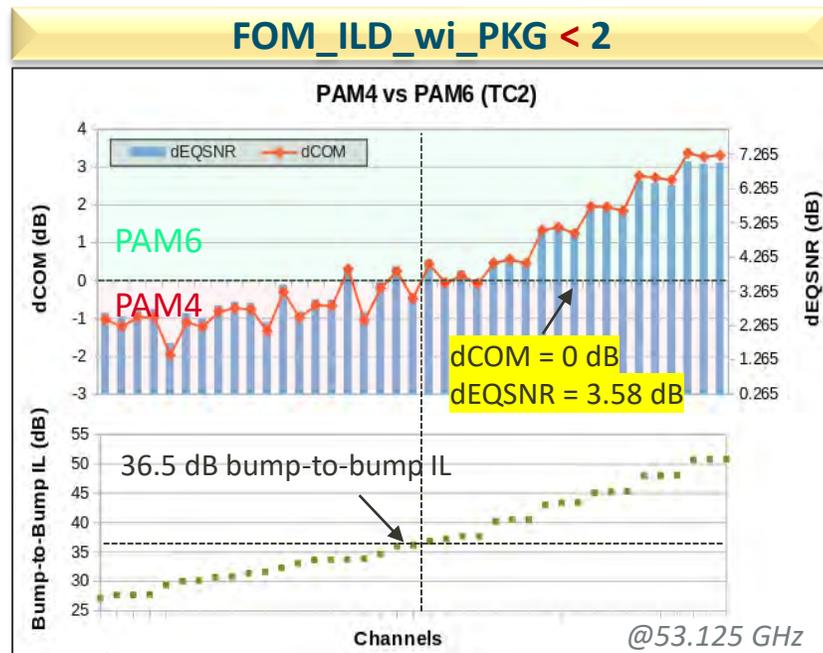


$$dCOM = COM(PAM6) - COM(PAM4)$$



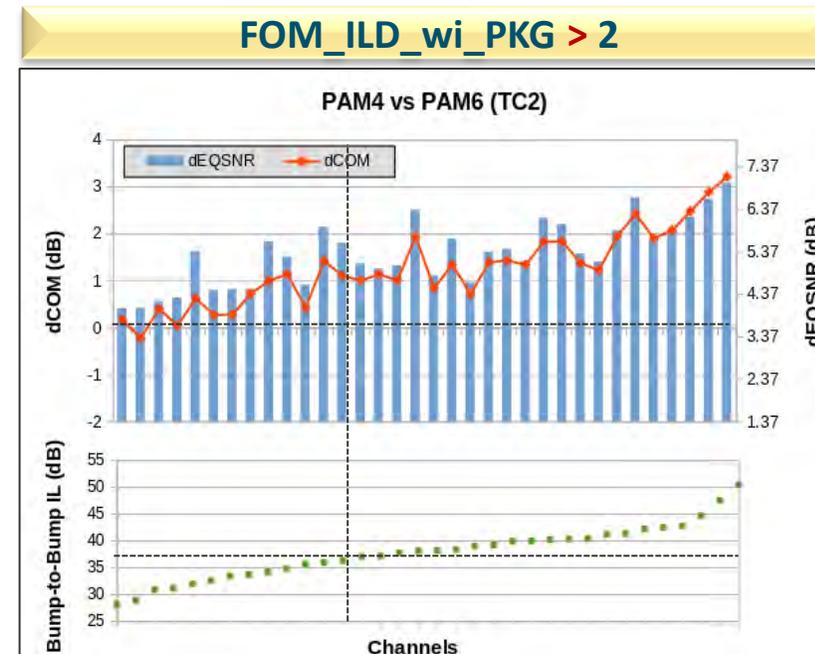
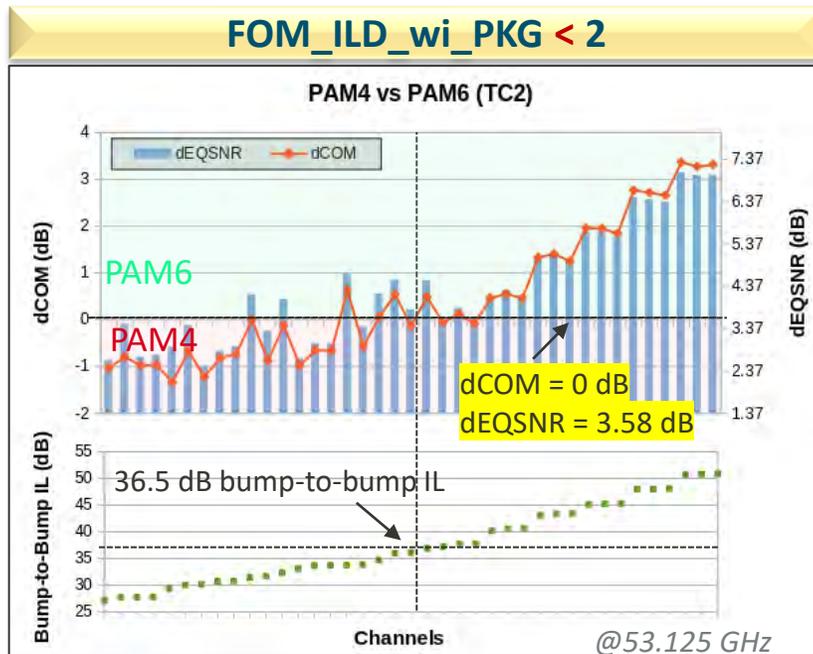
PAM4 vs PAM6 (wo Crosstalk)

- PAM4 shows the better overall performance under
 - Bump-to-bump IL @ 53.125 GHz \leq 36.5 dB
 - Channel bandwidth is sufficient (FOM_ILD_wi_PKG \leq 2)
- PAM6 outperform PAM4 when channel loss increases
- Channels with limit bandwidth enjoy higher performance gain when moving from PAM4 to PAM6



PAM4 vs PAM6 (wi Crosstalk)

- Crosstalk has a high-pass frequency response in general
- If signals can no longer maintain sufficient isolation, PAM6 gains a competitive advantage
- Required channel specifications as considering backward compatibility with 100G/L modulation format
 - BW/Reflection-related requirement: $ILD \leq 2\text{ dB}$?
 - Crosstalk requirement: $ICR \geq 25\text{ dB}$?



Conclusions of 200G/L CR

- **Feasibility of 200G/L PAM4 CR requires both channel and SerDes technology enablement**
 - Based on potential reach: bump2bump IL ~36.5 dB
- **Channel feasibility and the potential directions for channel design were explored**
 - FOM_ILD_wi_PKG \leq 2dB
 - ICR \geq 25 dB
- **SerDes feasibility started with the sensitivity check of key parameters, and the potential solutions to achieve 200G/L PAM4 CR were observed**
 - Increased TX swing under proper assessment of linearity & power consumption
 - More flexible DFE coefficient range with advanced RX technology
- **Baseline performance of PAM4 & PAM6 was compared under the assumption of identical transceiver capability**
 - PAM4 can outperform PAM6 under the well-qualified channel conditions

Further discussion

- **Whether 36.5 dB bump-to-bump IL target can meet the 200G/L CR objective with 1 m cable reach?**
- **Potential approaches to extend bump-to-bump IL target**
 - Further SerDes enhancement, e.g., increased A_v & $b_{\max}(1)$
 - Advanced RX technology, e.g., MLSD
 - PAM6

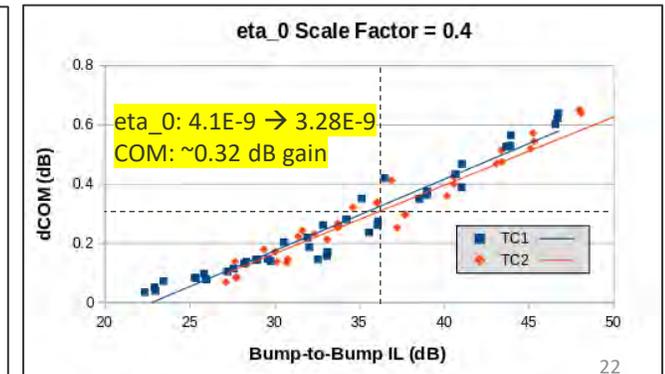
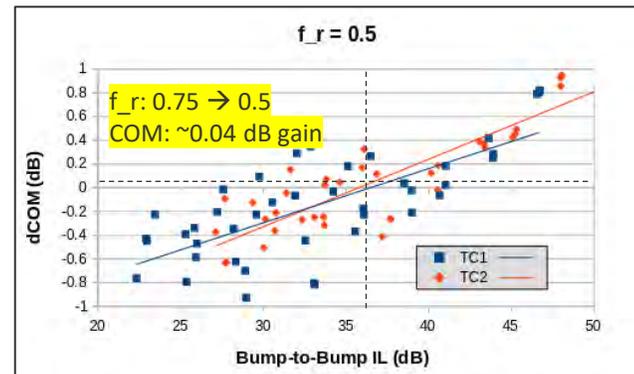
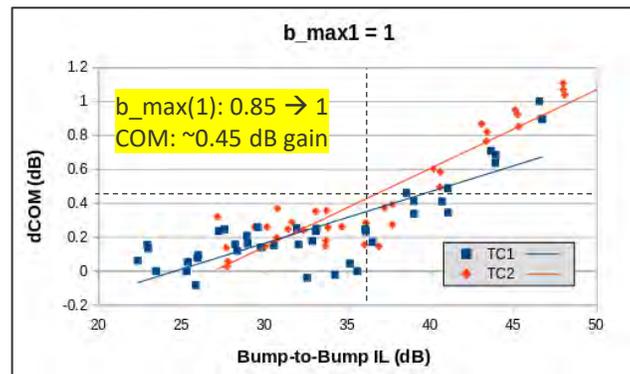
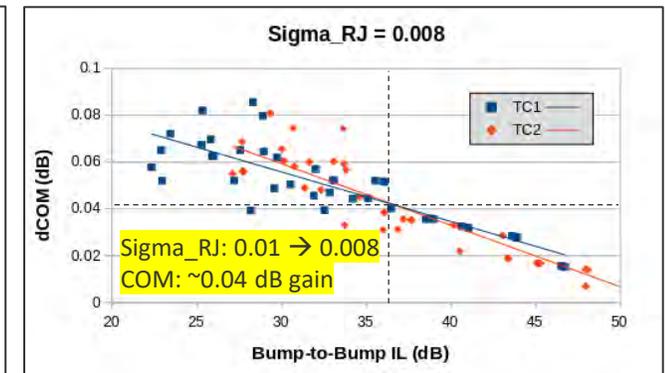
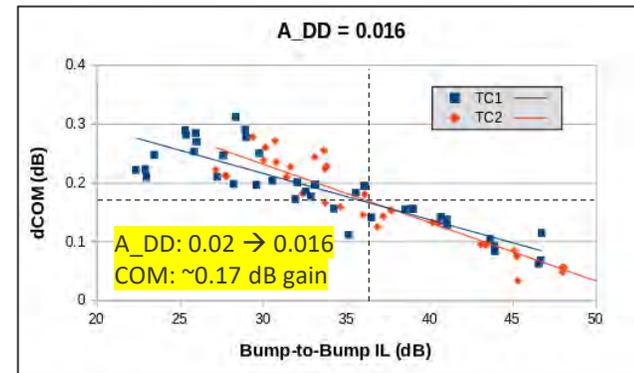
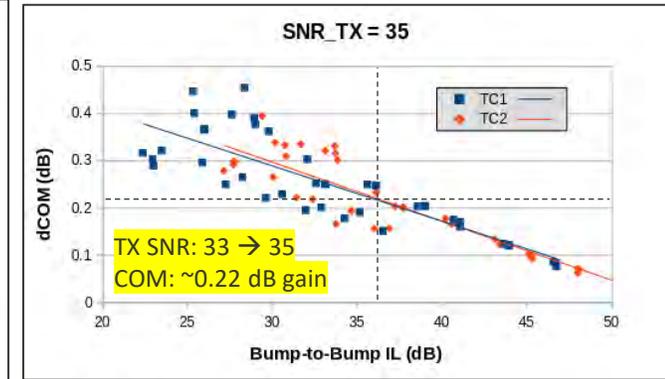
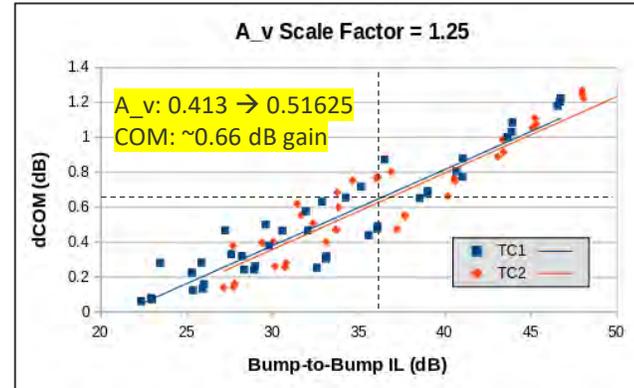
APPENDIX

Sensitivity to Transceiver Capability

**Remove channels with ILD > 2*

- Minor changes in performance trend and the resulting values when removing channels with FOM_ILD_wi_PKG > 2

	Changes from Baseline	Improvement	COM Gain
A_v	0.413 → 0.51625	25% increased	0.66 dB
SNR_TX	33 → 35	25% increased	0.22 dB
A_DD	0.02 → 0.016	20 % decreased	0.17 dB
Sigma_RJ	0.01 → 0.008	20 % decreased	0.04 dB
eta_0	4.1E-9 → 3.28E-9	20 % decreased	0.32 dB
f_r	0.75 → 0.5		0.04 dB
b_max(1)	0.85 → 1	17% increased	0.45 dB



COM Spreadsheet: PAM6

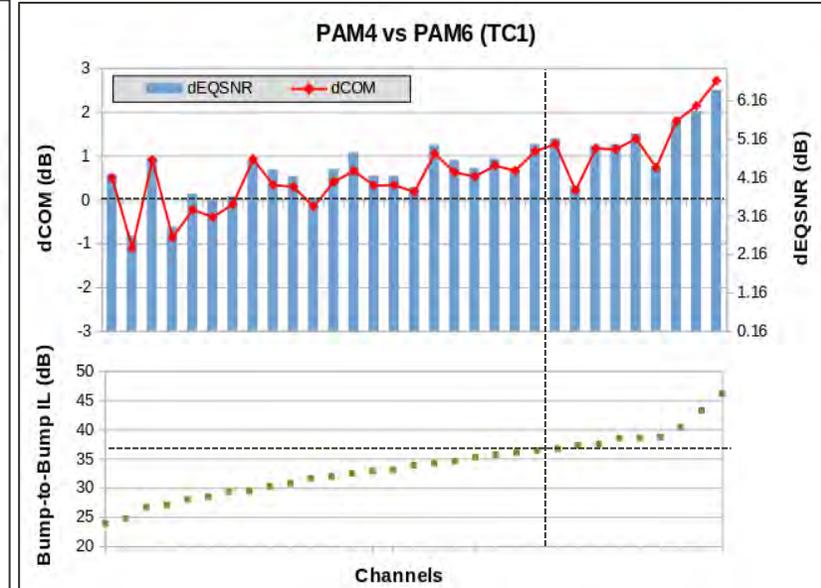
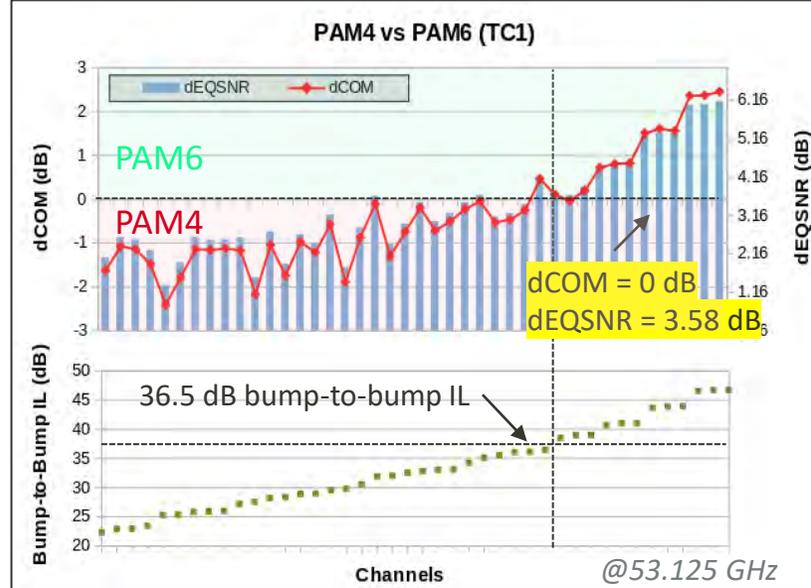
Table 93A-1 parameters				I/O control			Table 93A-3 parameters		
Parameter	Setting	Units	Information	Parameter	Setting	Units	Parameter	Setting	Units
f_b	82.2062215373401	GHz		DIAGNOSTICS	1	logical	package_fit_gamma0_a1_a2	[0 0.000644085 0.00018018]	
f_min	0.05	GHz		DISPLAY_WINDOW	0	logical	package_fit_tau	5.700E-03	ns/mm
Delta_f	0.01	GHz		CSV_REPORT	0	logical	package_Z_c	[87.5 87.5 ; 92.5 92.5]	Ohm
C_d	[0.7e-4 0.7e-4]	nF	[TX RX]	RESULT_DIR	.\results\100GEL_C2M_host_(date)		ICN & FOM_IJD parameters		
L_s	[0.12 0.12]	nH	[TX RX]	SAVE_FIGURES	0	logical	f_v	0.767	*F_b
C_b	[0.3e-4 0.3e-4]	nF	[TX RX]	Port Order	[1 3 2 4]		f_f	0.767	GHz f_r specified in first column
z_p select	[1 2]		[test cases to run]	RUNTAG	CR_eval		f_n	0.767	GHz
z_p (TX)	[12 31; 1.8 1.8]	mm	(test cases)	COM CONTRIBUTION	0	logical	f_2	80	GHz
z_p (NEXT)	[12 29; 1.8 1.8]	mm	(test cases)	Local Search	2		A_ft	0.600	V
z_p (FEXT)	[12 31; 1.8 1.8]	mm	(test cases)	Operational			A_nj	0.600	V
z_p (RX)	[12 29; 1.8 1.8]	mm	(test cases)	VEC Pass threshold	12	db	Histogram_Window_Weight		
C_p	[0.87e-4 0.87e-4]	nF	[TX RX]	EH_min	10	mV	gaussian		Selections (rectangle, gaussian, dual)
R_o	50	Ohm		ERL Pass threshold	9.5	dB	COM Pass threshold	3	
R_d	[50 50]	Ohm	[TX RX]	Min_VEO_Test	0	mV	Floating Tap Control		
A_v	0.413	V		DEF_0	0.0001		N_bg	3	0 1 2 or 3 groups
A_fe	0.413	V		T_r	0.0037496470898	ns	N_bf	6	taps per group
A_re	0.608	V		FORCE_TR	1	logical	N_f	80	UI span for floating taps
L	Δ			PMD_type	CR		bm_avg	0.2	max DFE value for floating taps
M	32	Samples/UI		BREAD_CRUMBS	0	logical			
samples_for_C2M	32	Samples/UI		SAVE_CONFIG2MAT	1	logical			
T_O	0	mUI		PLOT_CM	0	logical			
AC_CM_RMS	0	V	[test cases]	TDR and ERL options					
Filter and Eq				TDR	1	logical			
f_r	0.75	*f_b		ERL	1	logical			
c[0]	0.5		min	ERL_ONLY	0	logical			
c[-1]	[-0.4; 0.02; 0.04]		[min; step; max]	TR_TDR	0.00645936511945	ns			
c[-2]	[-0.1; 0.02; 0.2]		[min; step; max]	N	3500				
c[-3]	[-0.1; 0.02; 0.1]		[min; step; max]	beta_x	0				
c[1]	[-0.2; 0.02; 0.1]		[min; step; max]	rho_x	0.618				
N_b	24	UI		fixture delay time	[0 0]	[port1 port2]			
b_max[1]	0.85		As/dfe1	TDR_W_TXPKG	0				
b_max[2..N_b]	[0.5 0.3 0.3 0.2 ones(1,20)]		As/dfe2..N_b	N_bx	0	UI			
b_min[1]	0.3		As/dfe1	Tukey_Window	1				
b_min[2..N_b]	[0.20 0.50 0.95 -0.03 ones(1,20)]		As/dfe2..N_b	Receiver testing					
g_DC	[-20; 1; -2]	dB	[min; step; max]	RX_CALIBRATION	0	logical			
f_z	32.882488614936	GHz		Sigma_BBN_step	5.00E-03	V			
f_p1	32.882488614936	GHz		Noise jitter					
f_p2	82.2062215373401	GHz		sigma_RI	0.00773705014469	UI			
g_DC_HP	[-6; 1; 0]		[min; step; max]	A_DEI	0.01547411228938	UI			
f_HP_PZ	1.02767776921675	GHz		sigma_0	5.30E-09	V^2/GHz			
				SNR_TX	33	dB			
				R_LM	0.95				

PAM4 vs PAM6 (wo Crosstalk)

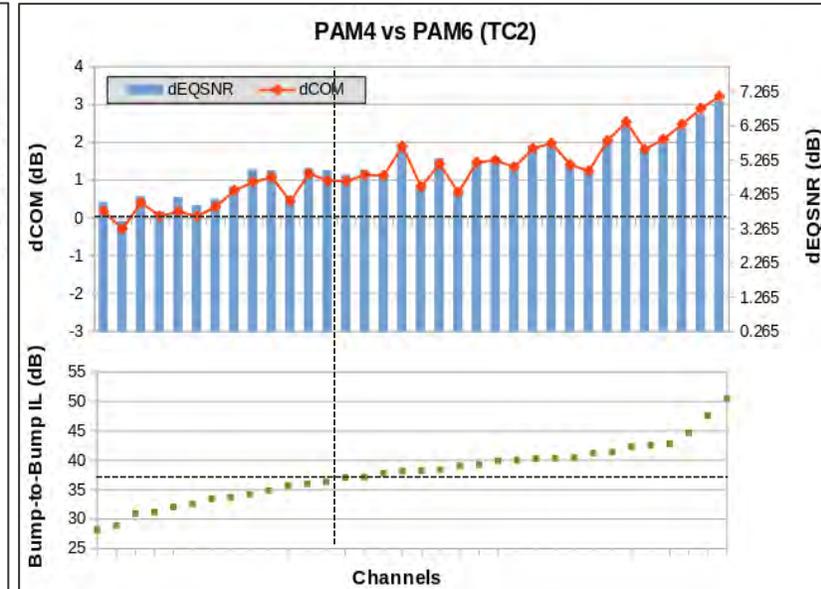
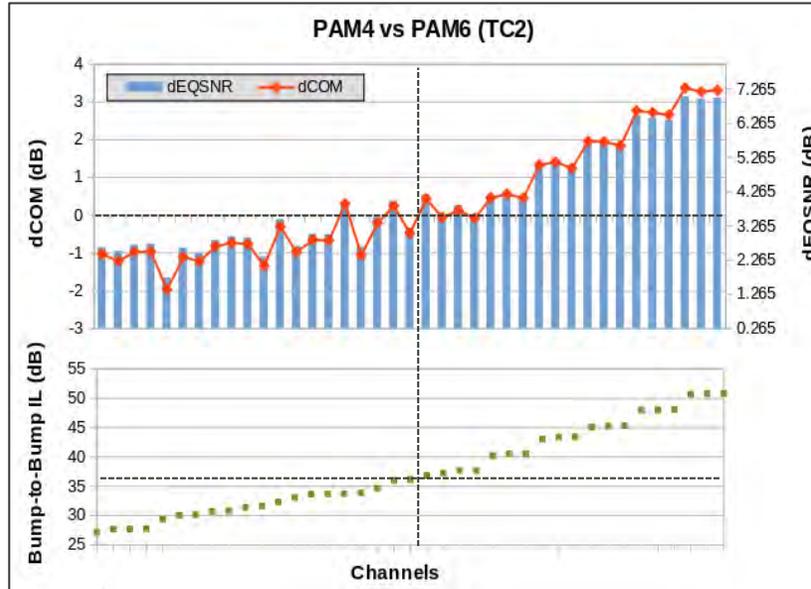
FOM_ILD_wi_PKG < 2

FOM_ILD_wi_PKG > 2

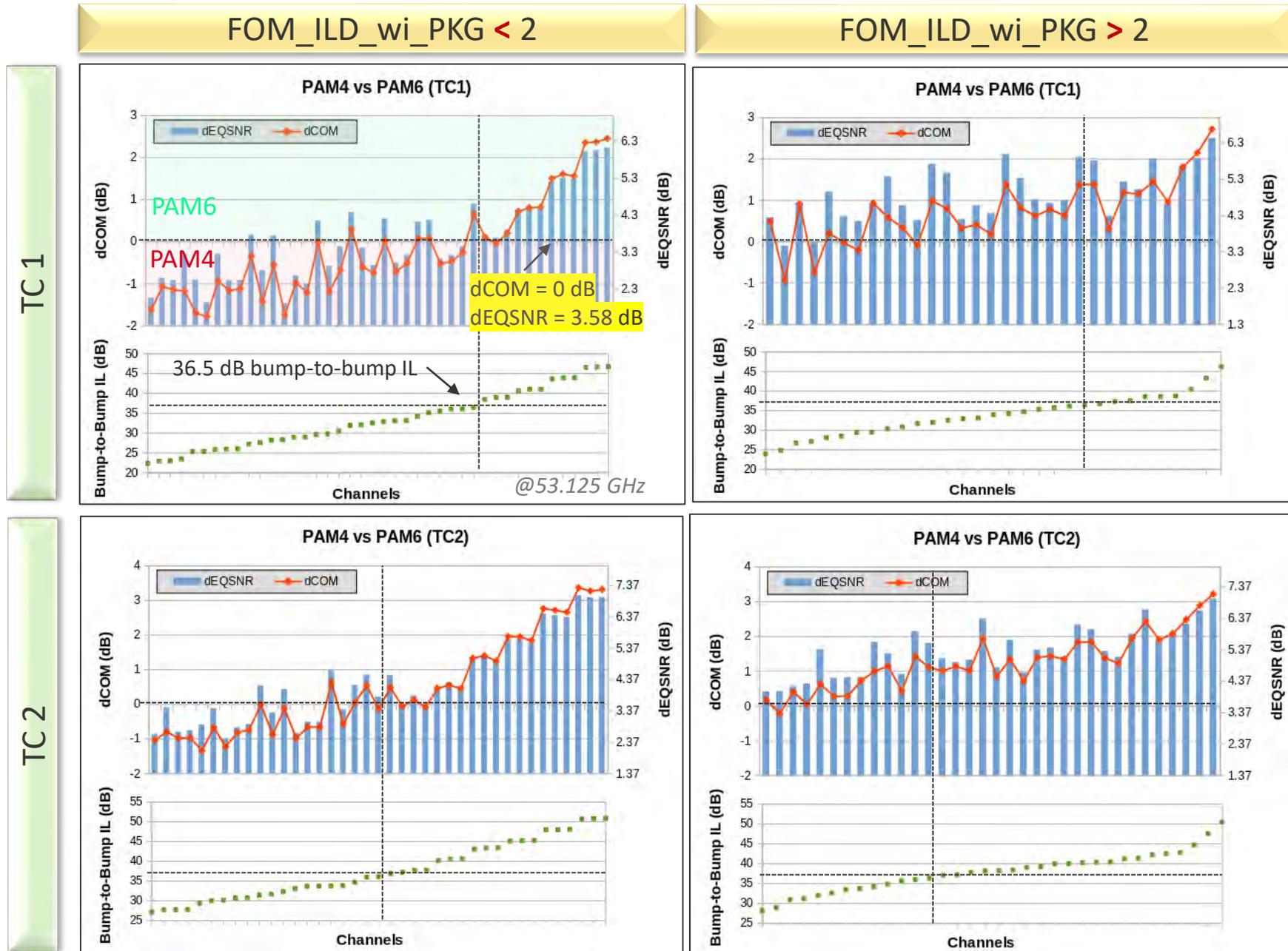
TC 1



TC 2



PAM4 vs PAM6 (wi Crosstalk)



THANK YOU